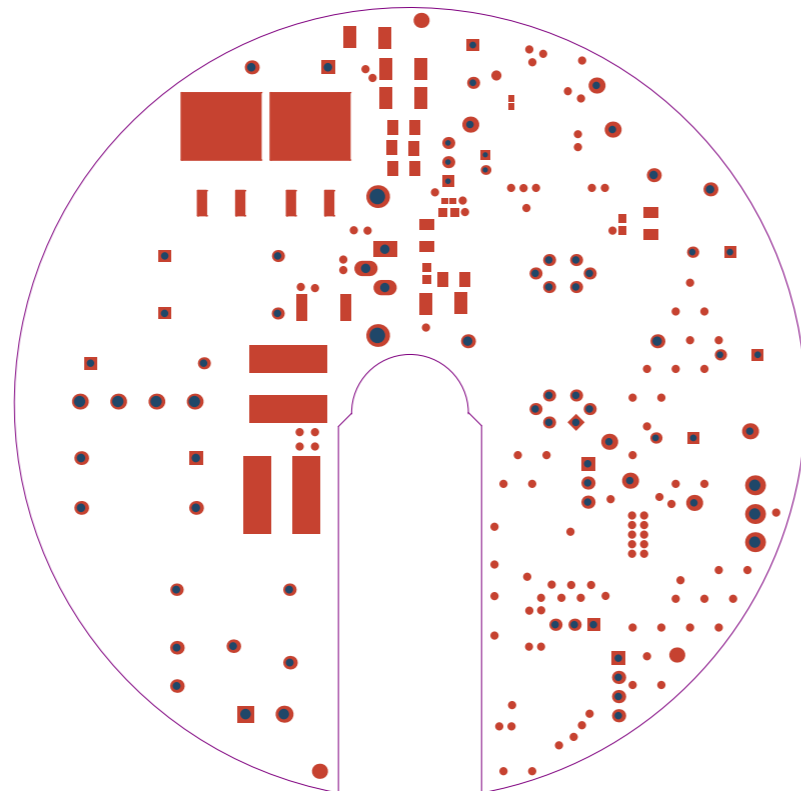
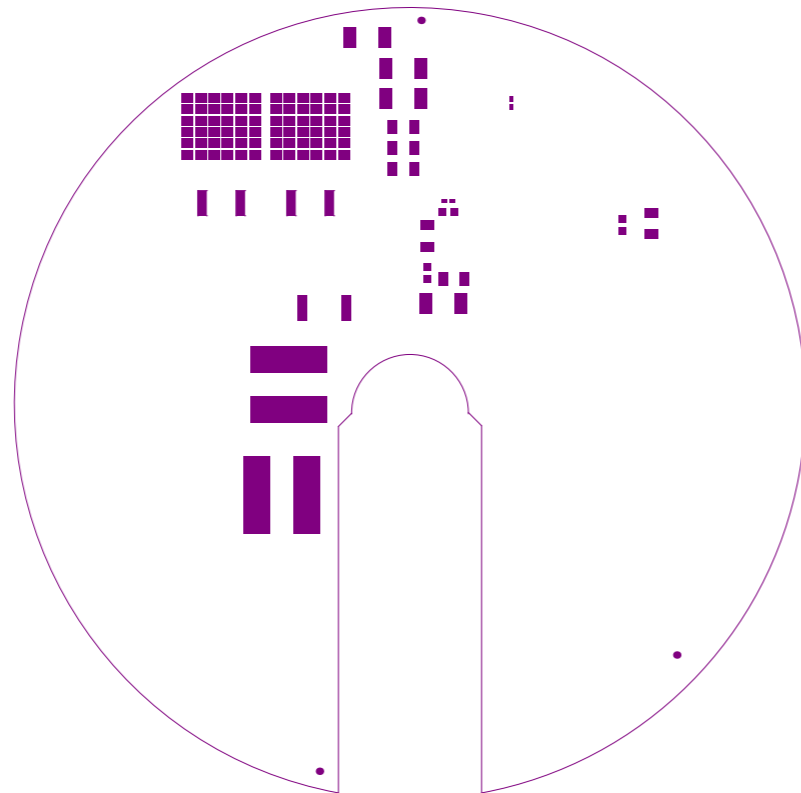


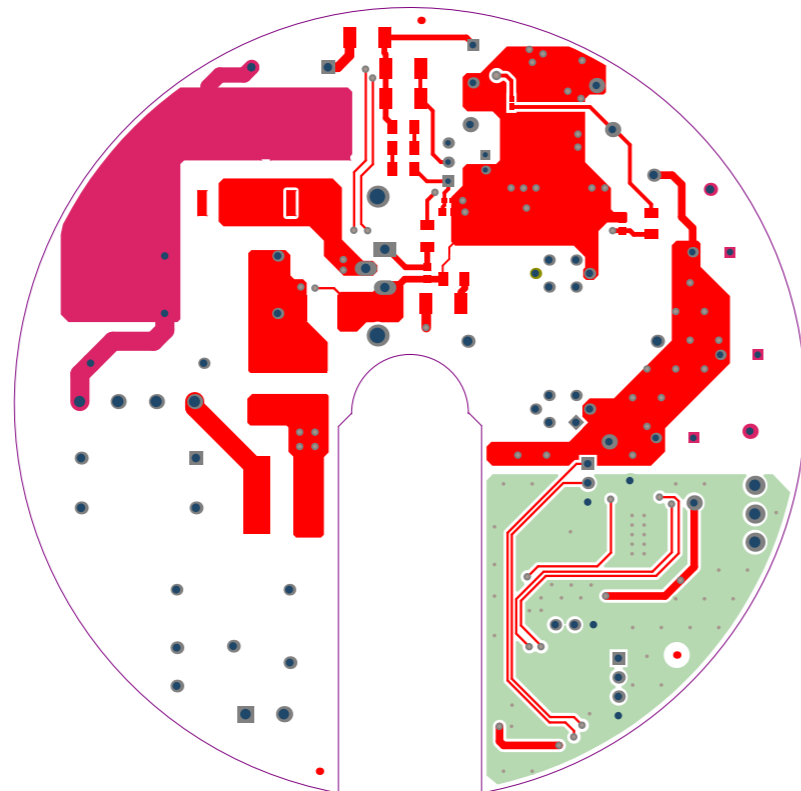
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00652	REV: E3	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME = Top Overlay	GENERATED : 10/26/2015 6:15:03 PM	TEXAS INSTRUMENTS	



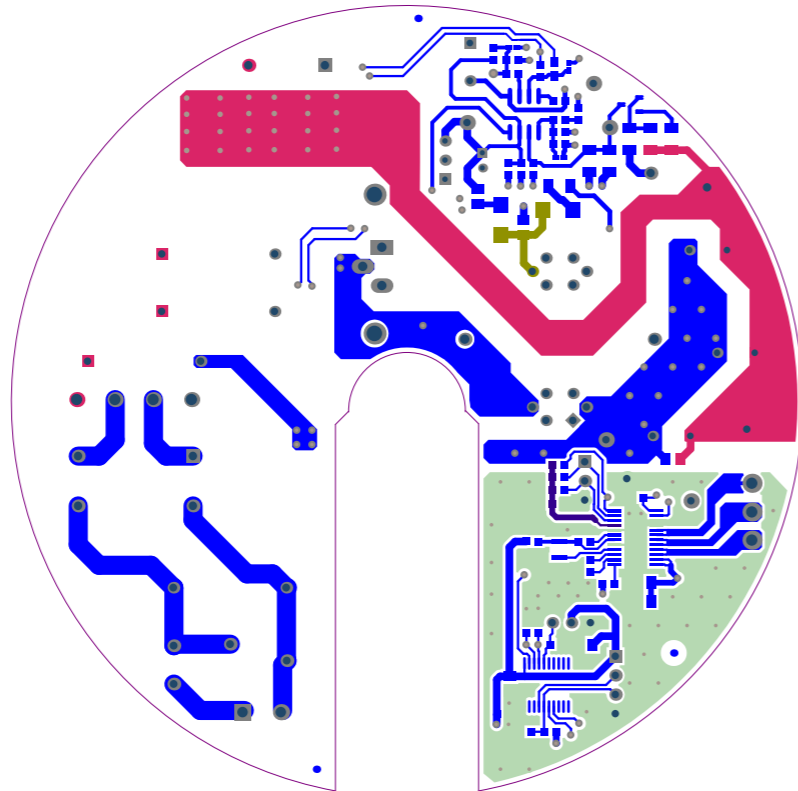
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00652	REV: E3	SUN REV: Not In VersionControl
LAYER NAME = Top Solder			
PLOT NAME = Top Solder Mask	GENERATED : 10/26/2015 6:15:03 PM	TEXAS INSTRUMENTS	



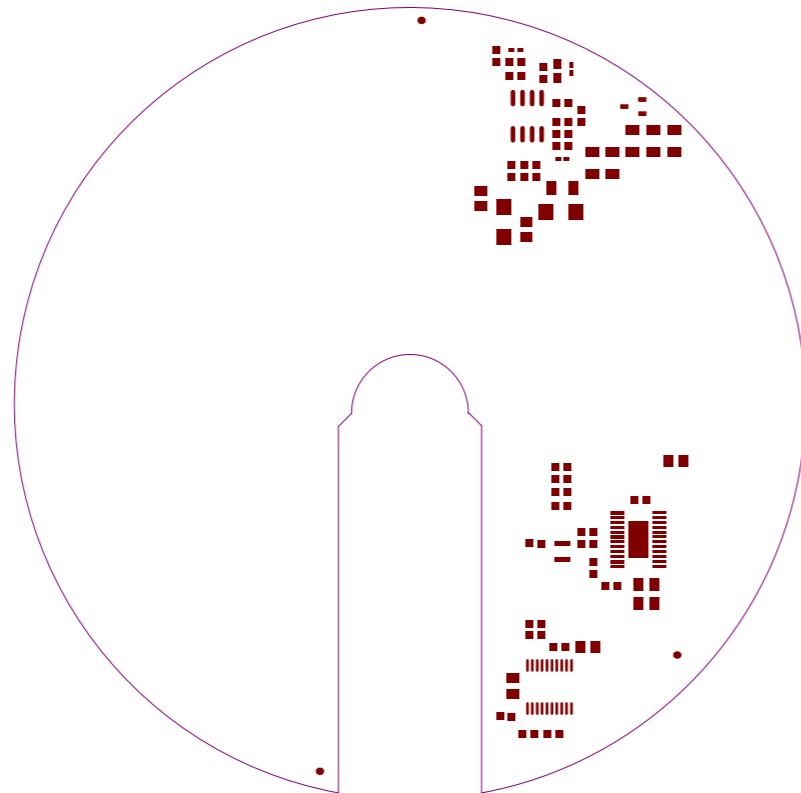
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LAYER NAME = Top Paste			
PLOT NAME = Top Paste	GENERATED : 10/26/2015 6:15:03 PM	TEXAS INSTRUMENTS	



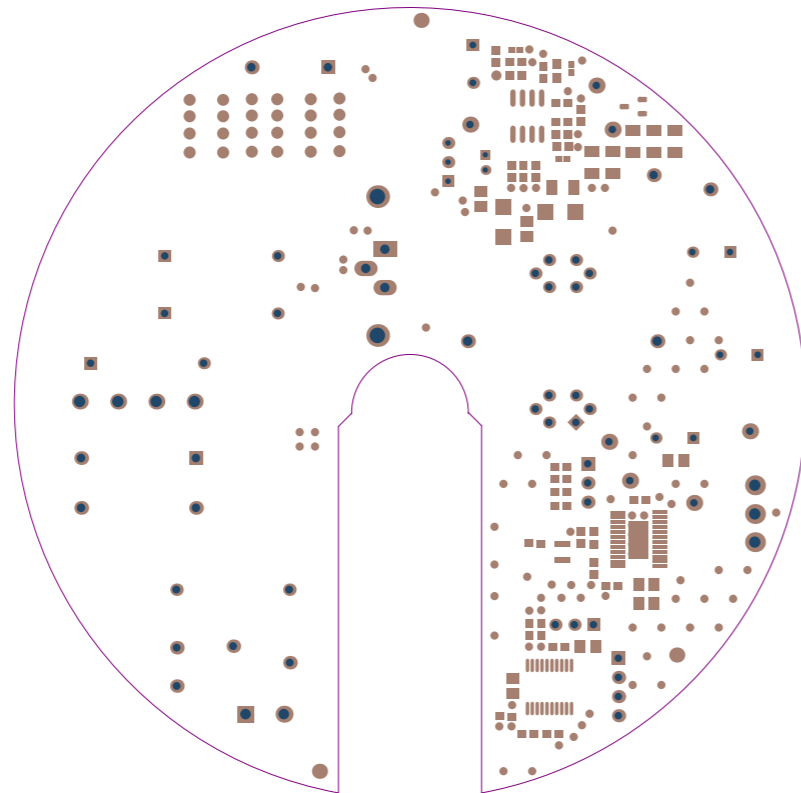
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LAYER NAME = Top Layer			
PLOT NAME = Top Layer	GENERATED : 10/26/2015 6:15:03 PM	TEXAS INSTRUMENTS	



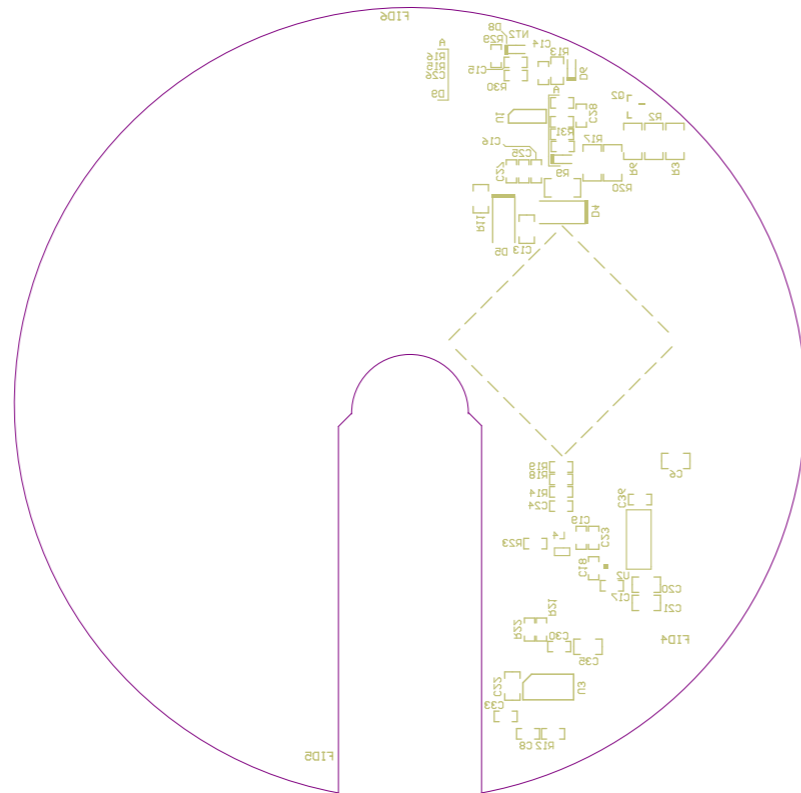
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LAYER NAME = Bottom Layer			
PLOT NAME = Bottom Layer	GENERATED : 10/26/2015 6:15:03 PM	TEXAS INSTRUMENTS	



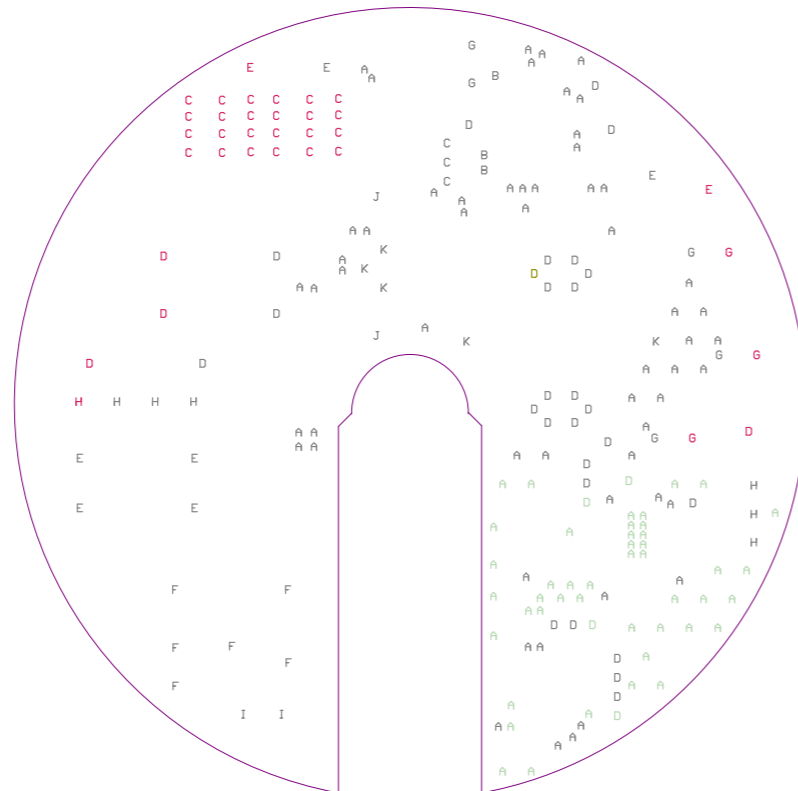
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00652	REV: E3	SUN REV: Not In VersionControl
LAYER NAME = Bottom Paste			
PLOT NAME = Bottom paste	GENERATED : 10/26/2015 6:15:03 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00652	REV: E3	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask	GENERATED : 10/26/2015 6:15:03 PM	TEXAS INSTRUMENTS	



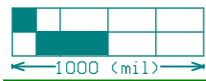
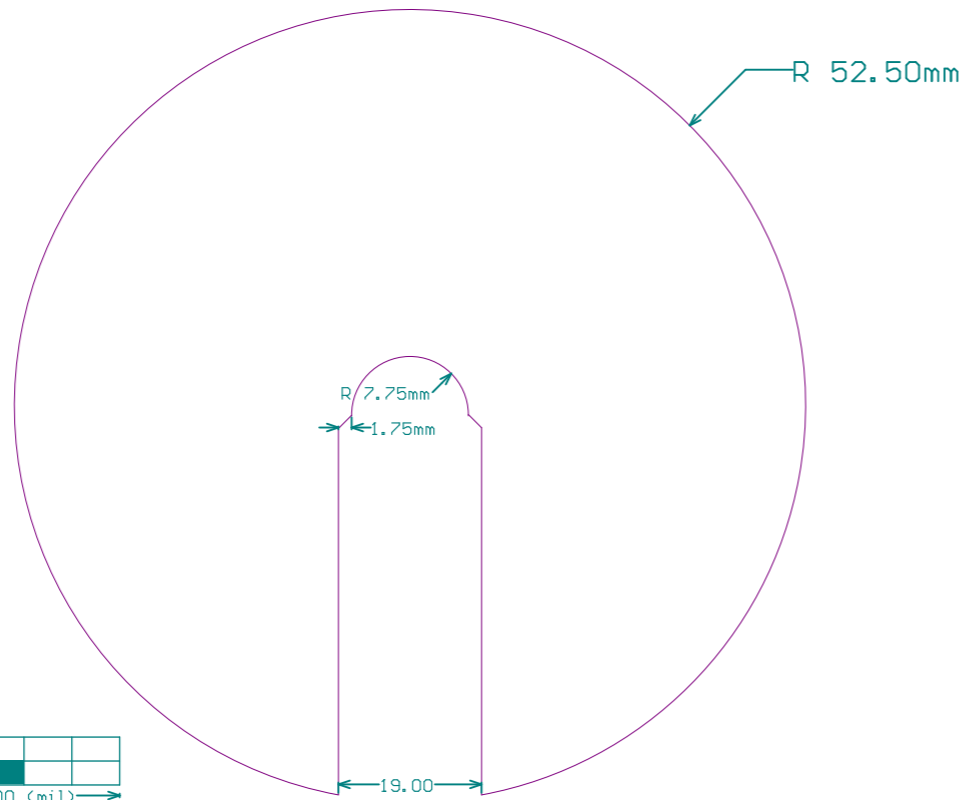
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00652	REV: E3	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay			
PLOT NAME = Bottom Overlay	GENERATED : 10/26/2015 6:15:03 PM	TEXAS INSTRUMENTS	



Symbol	Hit Count	Tool Size	Plated	Hole Type
A	102	20mil (0.508mm)	PTH	Round
B	3	28mil (0.711mm)	PTH	Round
C	27	30mil (0.762mm)	PTH	Round
G	8	35.433mil (0.9mm)	PTH	Round
D	35	40mil (1.016mm)	PTH	Round
F	6	42mil (1.067mm)	PTH	Round
E	8	45.3mil (1.151mm)	PTH	Round
K	5	50mil (1.27mm)	PTH	Round
I	2	55.118mil (1.4mm)	PTH	Round
H	7	60mil (1.524mm)	PTH	Round
J	2	82mil (2.083mm)	PTH	Round
205 Total				

Drill Table
 DRILL TOLERANCE
 FOR PTH +/- 3MIL

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00652	REV: E3	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 10/26/2015 6:15:03 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00652	REV: E3	SUN REV: Not In VersionControl
LAYER NAME =			
PLOT NAME = Board Dimensions	GENERATED : 10/26/2015 6:15:04 PM	TEXAS INSTRUMENTS	

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